

Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



FEATURES

- Low profile package - typical height of 0.88 mm
- Leadless DFN package with side-wettable flanks suitable for customer AOI (Automatic Optical Inspection)
- Very low voltage drop by TMBS Gen3 technology
- Low power losses, high efficiency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS

$I_{F(AV)}$	9 A
V_{RRM}	150 V
I_{FSM}	150 A
V_F at $I_F = 4.5$ A ($T_J = 125$ °C)	0.56 V
T_J max.	175 °C
Package	DFN33A
Circuit configuration	Single

TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: DFN33A

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)

PARAMETER	SYMBOL	V9N3M153	UNIT
Device marking code		9M153	
Maximum repetitive peak reverse voltage	V_{RRM}	150	V
Maximum average forward rectified current (fig. 1)	$I_{F(AV)}^{(1)}$	9	A
	$I_{F(AV)}^{(2)}$	2.4	A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	150	A
Operating junction temperature range	$T_J^{(3)}$	-40 to +175	°C
Storage temperature range	T_{STG}	-55 to +175	°C

Notes

(1) With infinite heatsink

(2) Free air, mounted on FR4 PCB, 2 oz., standard footprint

(3) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 4.5 A	T _J = 25 °C	V _F ⁽¹⁾	0.70	-	V
	I _F = 9 A			0.85	1.00	
	I _F = 4.5 A	T _J = 125 °C		0.56	-	
	I _F = 9 A			0.64	0.69	
Reverse current	V _R = 100 V	T _J = 25 °C	I _R ⁽²⁾	0.0014	-	mA
		T _J = 125 °C		1.2	-	
	V _R = 150 V	T _J = 25 °C	I _R ⁽²⁾	-	0.1	mA
		T _J = 125 °C		3	8	
Typical junction capacitance	4.0 V, 1 MHz		C _J	510	-	pF

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
 (2) Pulse test: pulse width $\leq 5\text{ ms}$

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Thermal resistance	$R_{\theta JA}$ (1)(2)	118	148	$^{\circ}\text{C/W}$
	$R_{\theta JA}$ (3)	-	65	
	$R_{\theta JM}$ (4)	2.9	3.63	

Notes

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$
 (2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint
 (3) Thermal resistance junction-to-ambient, free air with device mounted on FR4 PCB, 2 oz., 20 mm x 20 mm pad area
 (4) Thermal resistance junction-to-mount to follow JEDEC 51-14 transient dual interface test method (TDIM)

ORDERING INFORMATION TABLE

Device code	V	9	N3	M	15	3	H	M3
	①	②	③	④	⑤	⑥	⑦	⑧
①	- Vishay TMBS product							
②	- Current rating (9 = 9 A)							
③	- Package type (N3 = DFN33A)							
④	- Process type option (M = low I_R)							
⑤	- Voltage rating (15 = 150 V)							
⑥	- TMBS generation option (3 = Gen3)							
⑦	- Quality grade (H = AEC-Q101 qualified, otherwise = industry grade)							
⑧	- Material / environmental category (M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free)							

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V9N3M153-M3/I	0.031	I	6000	13" diameter plastic tape and reel
V9N3M153HM3/I (1)	0.031	I	6000	13" diameter plastic tape and reel

Note

- (1) AEC-Q101 qualified

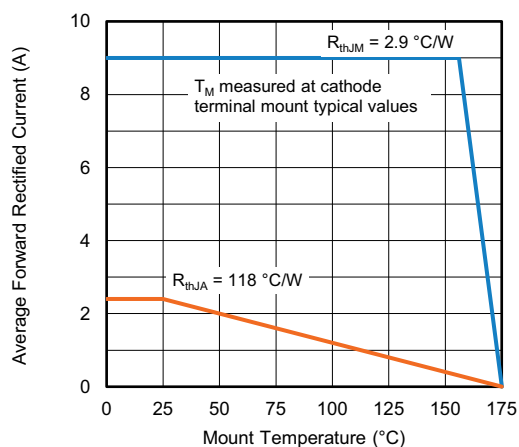
RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)


Fig. 1 - Maximum Forward Current Derating Curve

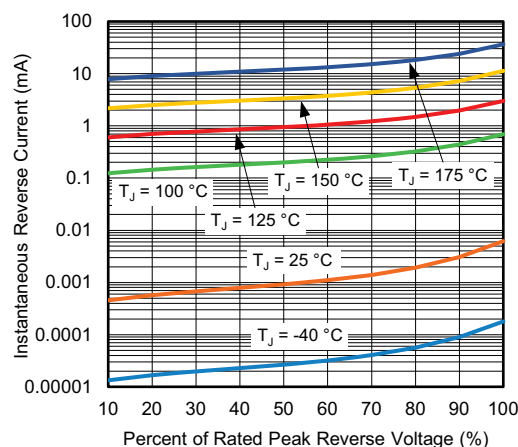


Fig. 4 - Typical Reverse Characteristics

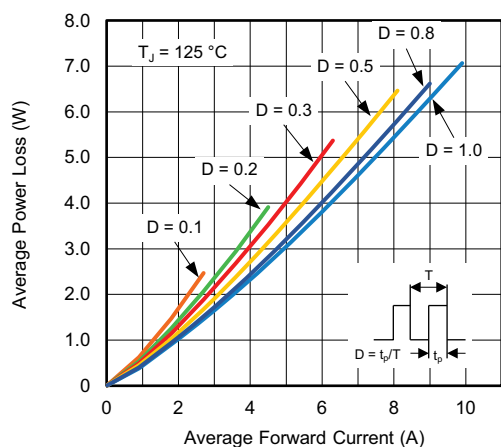


Fig. 2 - Forward Power Loss Characteristics

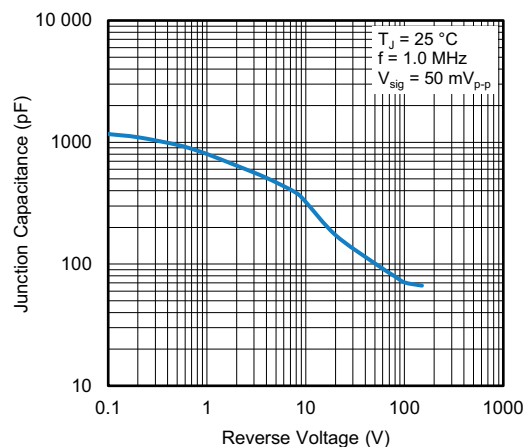


Fig. 5 - Typical Junction Capacitance

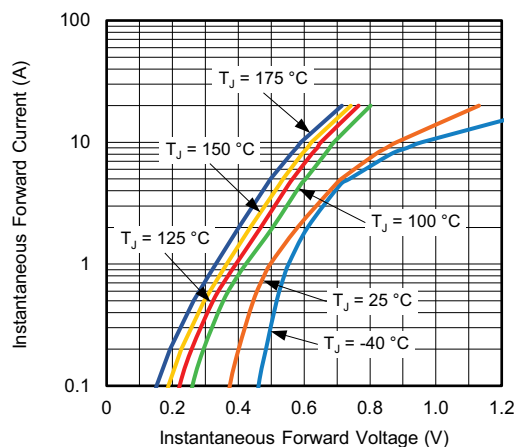


Fig. 3 - Typical Instantaneous Forward Characteristics

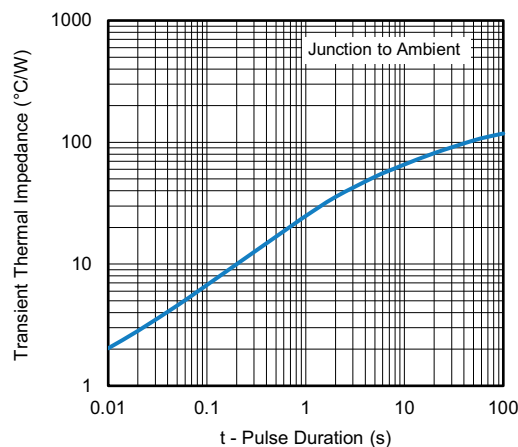


Fig. 6 - Typical Transient Thermal Impedance

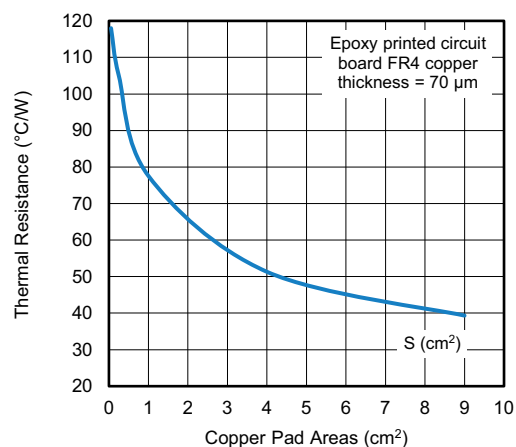


Fig. 7 - Thermal Resistance Junction-to-Ambient vs. Copper Pad Areas

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DFN33A





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